



भारतीय विमानपत्तन प्राधिकरण Airports Authority of India

Ref No: AAI/TPT/ENGG(E)/C-01/2024-25

Date: 28.08.2024

SCRUTINY OF COVER-I DOCUMENTS

Name of Work: Provision of Interleaving Circuits for PAPI and Separate Circuit for TWY-B at Tirupati Airport.

Tender ID: 2024_AAI_201823_1

The Bidder Details:

SL. No	Name of Agency	Remarks	Recommendation
01	M/s.Deepak Electricals, Katpadi Taluk, Vellore District-635803.	Not Meeting e-NIT Criteria	Not Recommended for acceptance of Cover-I
02	M/s Nasu Systems, Mumbai-400068.	Not Meeting e-NIT Criteria	Not Recommended for acceptance of Cover-I
03	M/s.Techno Electricals, Vadodara - 16	Meeting e-NIT Criteria	Recommended for acceptance of Cover-I

The Cover-I was opened and after scrutiny, 01 (One) bidder eligible for opening of Cover-II (Financial Bid).

(Digitally Signed)
Senior Manager (Engg-E)-II
AAI / Tirupati Airport / Renigunta